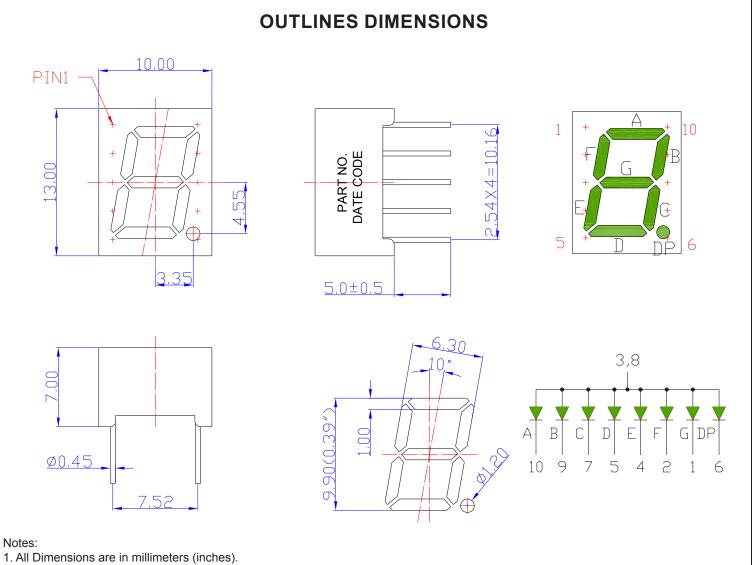


SPECIFICATIONS

CDSA39G2WF



2. Tolerance is \pm 0.25mm (0.01") unless otherwise noted.

3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Color of Emission Lens Type	
CDSA39G2WF	InGaAIP	Green	White Segment	Common Anode





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

Parameter	Symbol	Max Rating	Unit			
Power Dissipation	PD	85	mW			
Pulse Forward Current	lfp	120	mA			
Continuous Forward Current	lF	30	mA			
Reverse Voltage per dice	VR	5	V			
Operating Temperature Range	Topr	-25~+85	°C			
Storage Temperature Range	Тѕтс	-25~+85	°C			
IFP = Pulse Width \leq 10 ms, Duty Ratio \leq 1/10. Soldering Condition: 260 °C/ 5sec						

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

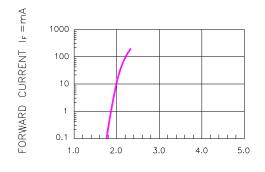
Deremeter	Symbol	Test Condition	Value			Linit
Parameter			Min	Тур	Max	Unit
Luminous Intensity	١v	l⊧ = 20mA	-	10	-	mcd
Forward Voltage	Vf	l⊧ = 20mA	-	2.1	2.6	V
Reverse Leakage Current	lr	V _R = 5V	-	-	10	μA
Peak Wavelength	λр	l⊧ = 20mA	-	573	-	nm
Dominant Wavelength	λd	l⊧ = 20mA	-	571	-	nm
Spectral Line half-width	Δλ	l⊧ = 20mA	-	20	-	nm

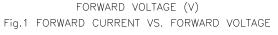


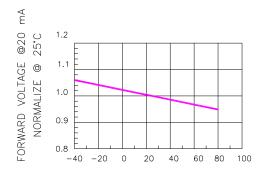


OPTICAL CHARACTERISTIC CURVES

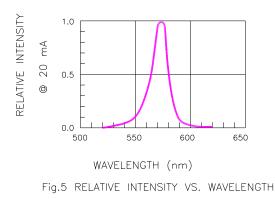
(25 °C Free Air Temperature Unless Otherwise Specified)

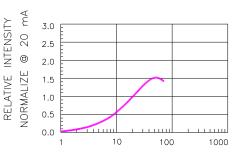






AMBIENT TEMPERATURE(°C) Fig.3 FORWARD VOLTAGE VS. TEMPERATURE





FORWARD CURRENT (mA) Fig.2 RELATIVE INTENSITY VS. FORWARD CURREN

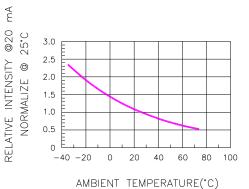
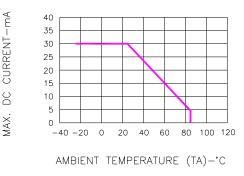
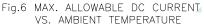


Fig.4 RELATIVE INTENSITY VS. TEMPERATUR



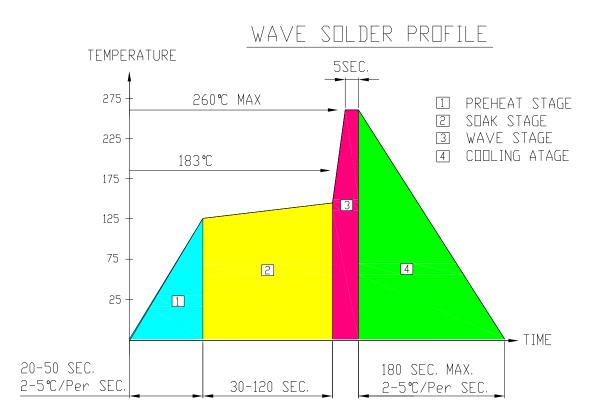






SOLDERING CONDITIONS – DISPLAY TYPE LED

RECOMMEND SOLDERING PROFILE



SOLDERING IRON

Basic spec is \leq 4 sec when 260°C. If temperature is higher, time should be shorter (+10°C→1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

REWORK

Customer must finish rework within ≦4 sec under 245°C.

